

# FRED Pt® Gen 4 Single Ultrafast Diode, 500 A (INT-A-PAK Power Modules)



INT-A-PAK

PRODUCT SUMMARY					
$V_{R}$	600 V				
I <sub>F(AV)</sub> at T <sub>C</sub>	500 A at 55 °C				
t <sub>rr</sub> at 25 °C	104 ns				
Туре	Modules - diode, high voltage				
Package	INT-A-PAK				
Circuit	Single diode				

#### **FEATURES**

- Gen 4 FRED Pt<sup>®</sup> dices technology
- Ultrasoft reverse recovery characteristics
- Low I<sub>RRM</sub> and reverse recovery charge
- · Very low forward voltage drop
- 175 °C operating junction temperature
- UL approved file E78996 for application with maximum case temperature up to 140 °C
- Large creepage distances
- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

#### **DESCRIPTION**

Gen 4 FRED Pt technology, state of the art, ultra low  $V_F$ , soft switching optimized for IGBT F/W diode.

The minimized conduction loss, optimized storage charge, and low recovery current, minimized the switching losses and reduce the over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V <sub>R</sub>		600	V	
Continuous forward current		T <sub>C</sub> = 25 °C	772		
	I <sub>F</sub>	T <sub>C</sub> = 90 °C	519	A	
Single pulse forward current	I <sub>FSM</sub>	$t_p$ = 10 ms, 50 Hz, sine half wave, initial $T_J$ = 175 °C	4500	,,	
Maximum power dissipation	P <sub>D</sub>	T <sub>C</sub> = 25 °C	1363	W	
		T <sub>C</sub> = 90 °C	772	VV	
Operating junction temperature range	TJ		-40 to +175	°C	
Storage temperature range	T <sub>Stg</sub>		-40 to +150		
RMS insulation voltage	V <sub>INS</sub>	50 Hz, circuit to base, all terminals shorted, t = 1 s	3500	V	

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS MIN.		TYP.	MAX.	UNITS	
Cathode to anode breakdown voltage	$V_{BR}$	I <sub>R</sub> = 500 μA	600	-	-		
Forward voltage drop	V <sub>FM</sub>	I <sub>F</sub> = 250 A	-	1.25	-		
		I <sub>F</sub> = 500 A	-	1.45	1.66	V	
		I <sub>F</sub> = 250 A, T <sub>J</sub> = 150 °C	-	1.23	-		
		I <sub>F</sub> = 500 A, T <sub>J</sub> = 150 °C	-	1.0	-		
Reverse leakage current	I <sub>RM</sub>	V <sub>R</sub> = 600 V	-	2.0	200	μA	
		T <sub>J</sub> = 150 °C, V <sub>R</sub> = 600 V	-	1.8	-	mA	



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS	
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 150 A dl/dt = 1000 A/μs V <sub>R</sub> = 300 V	-	104	-	ns
		T <sub>J</sub> = 125 °C		-	193	-	
Peak recovery current	I <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	59	-	Α
		T <sub>J</sub> = 125 °C		-	122	-	
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	3.5	-	μC
		T <sub>J</sub> = 125 °C		-	13.8	-	

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL TEST CONDITIONS		VALUES	UNITS	
	Maximum thermal resistance, junction to case per leg		DC operation	0.11	K/W	
Typical thermal resistance, case to heat sink		R <sub>thCS</sub>	Mounting surface, flat, smooth and greased	0.035	r, vv	
Mounting to heat sink			A mounting compound is recommended and the	4+- 0	Nima	
torque ± 10 % busbar	busbar		torque should be rechecked after a period of 3 hours to allow the spread of the compound.	4 to 6	Nm	
Approximate weight				200	g	
				7.1	OZ.	
Case style				INT-A-PAK		

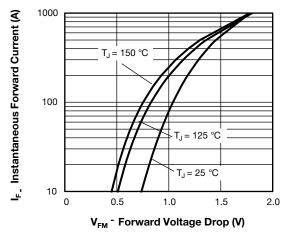


Fig. 1 - Typical Forward Voltage Drop Characteristics

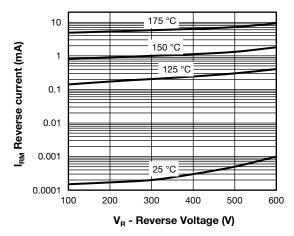


Fig. 2 - Typical Value of Reverse Current vs. Reverse Voltage

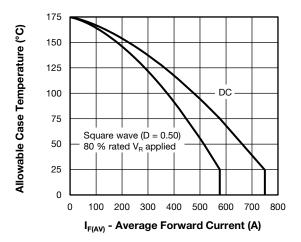


Fig. 3 - Maximum Allowable Case Temperature vs. Average Forward Current

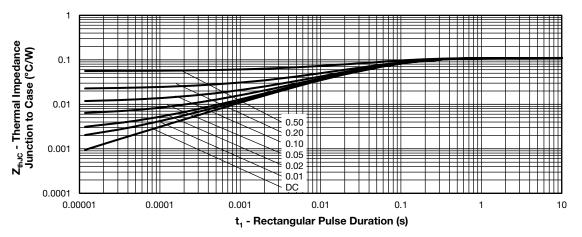


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

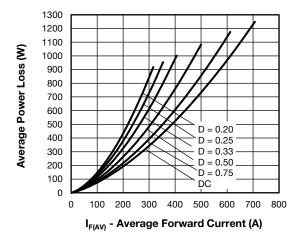


Fig. 5 - Forward Power Loss Characteristics

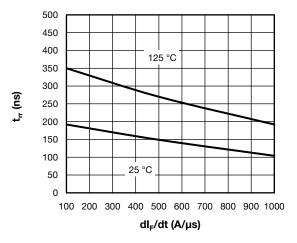


Fig. 6 - Typical Reverse Recovery Time vs.  $dI_F/dt$   $I_{FM} = 150 \text{ A}, V_R = 300 \text{ V}$ 

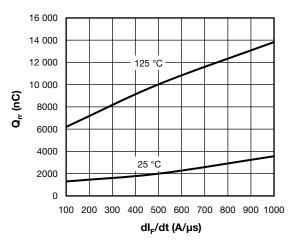


Fig. 7 - Typical Reverse Recovery Charge vs.  $dI_F/dt$   $I_{FM} = 150 \text{ A}, V_R = 300 \text{ V}$ 

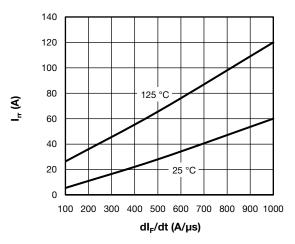
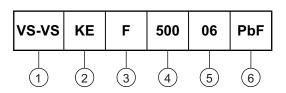


Fig. 8 - Typical Reverse Recovery Current vs.  $dI_F/dt$   $I_{FM} = 150$  A,  $V_R = 300$  V

#### **ORDERING INFORMATION TABLE**

**Device code** 



Vishay Semiconductors product

Circuit configuration: KE = single diode

F = FRED Pt<sup>®</sup> ultrafast diode

4 - Current rating (500 = 500 A)

5 - Voltage rating (06 = 600 V)

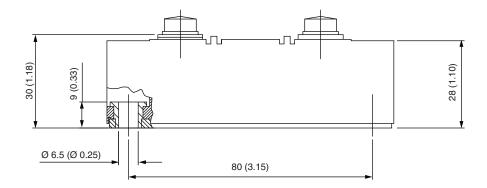
6 - PbF = lead (Pb)-free

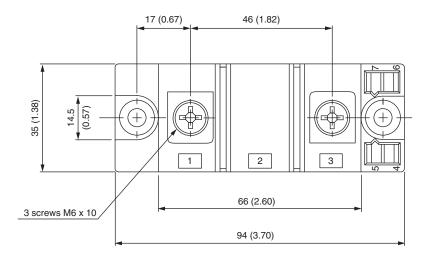
#### **CIRCUIT CONFIGURATION**

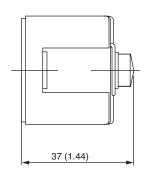




#### **DIMENSIONS** in millimeters (inches)









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Vishay

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